Class X2

Metallized Impregnated Paper EMI Suppression Capacitors PME271M, Class X2, 275 VAC

Overview

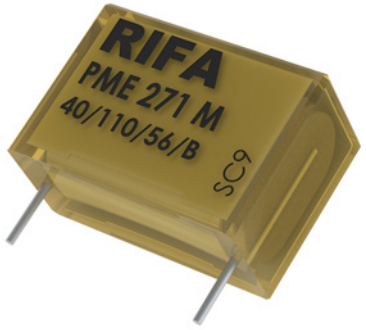
The PME271M is constructed of multilayer metallized paper encapsulated and impregnated in self-extinguishing material meeting the requirements of UL 94 V–0.

Applications

Typical applications include worldwide use in electromagnetic interference suppression in all X2 and across-the-line applications.

Benefits

- Approvals: ENEC, UL, cUL
- Rated voltage: 275 VAC 50/60 Hz
- Capacitance range: 0.001 – 0.6 µF
- Lead spacing: 10.2 – 25.4 mm
- Capacitance tolerance: M = ±20% (for C ≤ 0.1 µF), K = ±10% (for C > 0.1 µF)
- Climatic category: 40/110/56, IEC 60068–1
- Tape and reel in accordance with IEC 60286–2
- RoHS Compliant and lead-free terminations
- Operating temperature range of −40°C to +110°C
- 100% screening factory test at 2,150 VDC



Customer Part Number

PME271	M	(B)	610(0)	M	R30
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
X2, Metallized Paper	M = 275	Blank = Standard A = 10.2 B = 15.2 D = 22.5	The last three digits represent significant figures. The first digit specifies the total number of digits.	M = ±20% (for C ≤ 0.1 µF) K = ±10% (for C > 0.1 µF)	See Ordering Options Table

KEMET Internal Part Number

P	276	Q	E	104	M	275	A
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Packaging
P = Paper	X2, Metallized Paper	H = 10.2 Q = 15.2 C = 20.3 S = 22.5 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20% (for C ≤ 0.1 µF) K = ±10% (for C > 0.1 µF)	275 = 275	See Ordering Options Table

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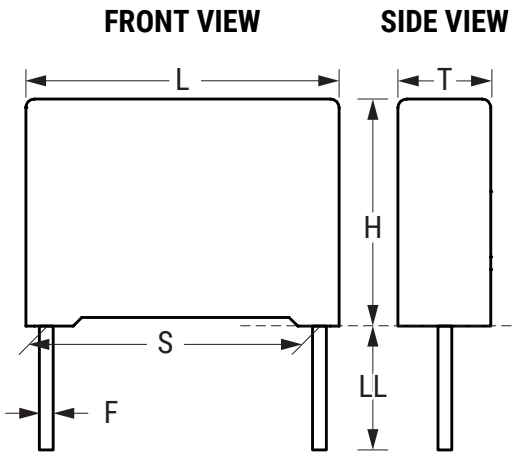
Benefits cont.

- The highest possible safety regarding active and passive flammability
- Excellent self-healing properties ensure long life even when subjected to frequent over voltages
- Good resistance to ionization due to impregnated dielectric
- High dV/dt capability
- The impregnated paper ensures excellent stability and outstanding reliability properties, especially in applications with continuous operation

Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
10.2	**Standard Lead and Packaging Options**			
	Bulk (Bag) – Short Leads	6 +0/–1	C	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/–0	A	R30
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	P	R19T1
Native 10.2 formed to 7.5	Ammo Pack	H_0 = 16.5 ±0.5	LAF3	R30XA
15.2	**Standard Lead and Packaging Options**			
	Bulk (Bag) – Short Leads	6 +0/–1	C	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/–0	A	R30
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	P	R19T1
20.3	**Standard Lead and Packaging Options**			
	Bulk (Tray) – Short Leads	6 +0/–1	C	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/–0	A	R30
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H_0 = 18.5 ±0.5	P	R19T1
22.5	**Standard Lead and Packaging Options**			
	Bulk (Bag) – Short Leads	6 +0/–1	C	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/–0	A	R30
	Tape & Reel (Standard Reel)	H_0 = 18.5 ±0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H_0 = 18.5 ±0.5	P	R19T1
25.4	**Standard Lead and Packaging Options**			
	Bulk (Tray) – Short Leads	6 +0/–1	C	R06
	Bulk (Bag) – Maximum Length Leads	30 +5/–0	A	R30

Dimensions – Millimeters



Size Code	S		T		H		L		F	
	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
HE	10.2	±0.4	3.9	Maximum	7.5	Maximum	13.5	Maximum	0.6	±0.05
HH	10.2	±0.4	4.1	Maximum	8.2	Maximum	13.5	Maximum	0.6	±0.05
HL	10.2	±0.4	5.1	Maximum	10.5	Maximum	13.5	Maximum	0.6	±0.05
QE	15.2	±0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	±0.05
QL	15.2	±0.4	6.0	Maximum	12.5	Maximum	18.5	Maximum	0.8	±0.05
QP	15.2	±0.4	7.8	Maximum	13.5	Maximum	18.5	Maximum	0.8	±0.05
QS	15.2	±0.4	8.5	Maximum	14.3	Maximum	18.5	Maximum	0.8	±0.05
CE	20.3	±0.4	7.6	Maximum	14.0	Maximum	24.0	Maximum	0.8	±0.05
CJ	20.3	±0.4	9.0	Maximum	15.0	Maximum	24.0	Maximum	0.8	±0.05
CP	20.3	±0.4	11.3	Maximum	16.5	Maximum	24.0	Maximum	0.8	±0.05
SJ	22.5	±0.4	8.0	Maximum	17.0	Maximum	27.0	Maximum	0.8	±0.05
SP	22.5	±0.4	10.0	Maximum	19.0	Maximum	27.0	Maximum	0.8	±0.05
SU	22.5	±0.4	12.0	Maximum	22.0	Maximum	27.0	Maximum	0.8	±0.05
EG	25.4	±0.4	10.5	Maximum	17.3	Maximum	30.5	Maximum	1.0	±0.05
EJ	25.4	±0.4	12.1	Maximum	19.0	Maximum	30.5	Maximum	1.0	±0.05
EL	25.4	±0.4	15.3	Maximum	22.0	Maximum	30.5	Maximum	1.0	±0.05

Note: See Ordering Options Table for lead length (LL) options.

Performance Characteristics

Rated Voltage	275 VAC 50/60 Hz	
Capacitance Range	0.001 – 0.6 µF	
Capacitance Tolerance	±20%, ±10%, ±5% on request	
Temperature Range	–40°C to +110°C	
Climatic Category	40/110/56	
Approvals	ENEC, UL, cUL	
Dissipation Factor	Maximum Values at +23°C	
	1 kHz	1.3%
Test Voltage Between Terminals	The 100% screening factory test is carried out at 2,150 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. It is not permitted to repeat this test as there is a risk to damage the capacitor. KEMET is not liable in such case for any failures.	
Insulation Resistance	Minimum Values Between Terminals	
	C ≤ 0.33 µF	≥ 12,000 MΩ
	C > 0.33 µF	≥ 4,000 MΩ • µF
In DC Applications	Recommended voltage ≤ 630 VDC	

Environmental Test Data

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384–14	1.25 x V_R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068–2–6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s^2
Bump	IEC 60068–2–29 Test Eb	1,000 bumps at 390 m/s^2
Change of Temperature	IEC 60068–2–14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384–14	V_R + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384–14	IEC 60384–1, IEC 60695–11–5 Needle-flame test
Damp Heat Steady State	IEC 60068–2–78 Test Cab	+40°C and 93% RH, 56 days

Approvals

Certification Body	Mark	Specification	File Number
Intertek Semko AB		EN/IEC 60384–14	SE/0140–16D
UL		UL 60384–14 CAN/CSA–E60384–14–09	E73869

Environmental Compliance

All KEMET EMI capacitors are RoHS Compliant.

Table 1 – Ratings & Part Number Reference

Capacitance Value (µF)	Maximum Dimensions in mm			Lead Spacing (S)	f_o (MHz)	dV/dt (V/µs)	KEMET Part Number	Legacy Part Number
	T	H	L					
0.001	3.9	7.5	13.5	10.2	53	1,200	P276HE102M275(1)	PME271M410M(1)
0.0015	3.9	7.5	13.5	10.2	44	1,200	P276HE152M275(1)	PME271M415M(1)
0.0022	3.9	7.5	13.5	10.2	37	1,200	P276HE222M275(1)	PME271M422M(1)
0.0033	4.1	8.2	13.5	10.2	30	1,200	P276HH332M275(1)	PME271M433M(1)
0.0047	5.1	10.5	13.5	10.2	24	1,200	P276HL472M275(1)	PME271M447M(1)
0.0068	5.1	10.5	13.5	10.2	21	1,200	P276HL682M275(1)	PME271MA4680M(1)
0.0068	5.2	10.5	18.5	15.2	19	1,200	P276QE682M275(1)	PME271M468M(1)
0.010	5.2	10.5	18.5	15.2	16	1,200	P276QE103M275(1)	PME271M510M(1)
0.015	5.2	10.5	18.5	15.2	13	1,200	P276QE153M275(1)	PME271M515M(1)
0.022	6	12.5	18.5	15.2	10	1,200	P276QL223M275(1)	PME271M522M(1)
0.033	6	12.5	18.5	15.2	8.4	1,200	P276QL333M275(1)	PME271M533M(1)
0.047	6	12.5	18.5	15.2	7	1,200	P276QL473M275(1)	PME271M547M(1)
0.068	7.8	13.5	18.5	15.2	5.6	1,200	P276QP683M275(1)	PME271M568M(1)
0.1	8.5	14.3	18.5	15.2	4.3	1,200	P276QS104M275(1)	PME271MB6100M(1)
0.1	7.6	14	24	20.3	4.1	600	P276CE104M275(1)	PME271M610M(1)
0.15	9	15	24	20.3	3.4	600	P276CJ154K275(1)	PME271M615K(1)
0.22	11.3	16.5	24	20.3	2.7	600	P276CP224K275(1)	PME271M622K(1)
0.1	8	17	27	22.5	3.9	600	P276SJ104M275(1)	PME271MD6100M(1)
0.15	8	17	27	22.5	3.3	600	P276SJ154K275(1)	PME271MD6150K(1)
0.22	10	19	27	22.5	2.6	600	P276SP224K275(1)	PME271MD6220K(1)
0.27	12	22	27	22.5	2.3	400	P276SU274K275(1)	PME271MD6270K(1)
0.33	12	22	27	22.5	2.1	400	P276SU334K275(1)	PME271MD6330K(1)
0.27	10.5	17.3	30.5	25.4	2.4	400	P276EG274K275(1)	PME271M627K(1)
0.33	12.1	19	30.5	25.4	2.1	400	P276EJ334K275(1)	PME271M633K(1)
0.47	15.3	22	30.5	25.4	1.8	400	P276EL474K275(1)	PME271M647K(1)
0.6	15.3	22	30.5	25.4	1.6	400	P276EL604K275(1)	PME271M660K(1)
Capacitance Value (µF)	**T (mm)**	**H (mm)**	**L (mm)**	**Lead Spacing (S)**	**f_o (MHz)**	**dV/dt (V/µs)**	**KEMET Part Number**	**Legacy Part Number**

(1) Insert ordering code for lead type and packaging. See Ordering Options Table for available options.

Soldering Process

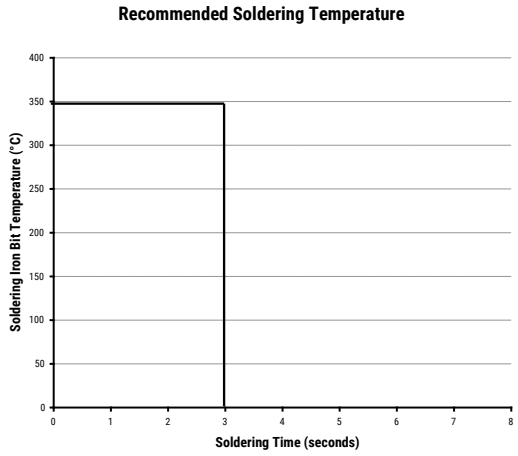
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183ºC for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 – 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760–1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

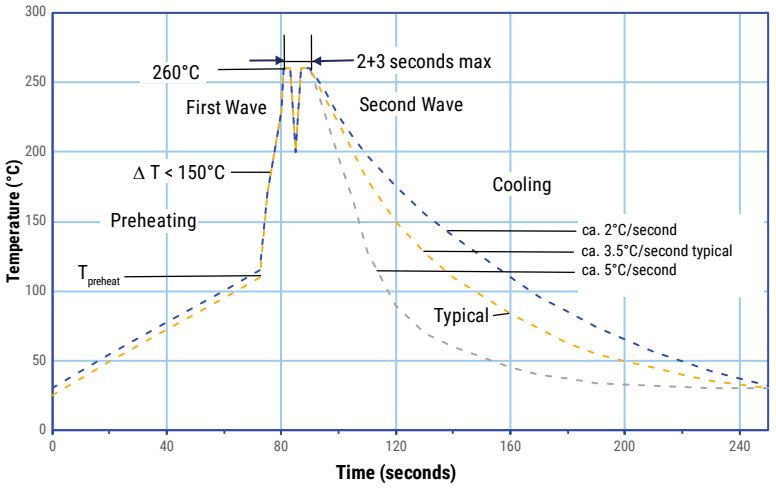
Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

Wave Soldering Recommendations



Soldering Process cont.

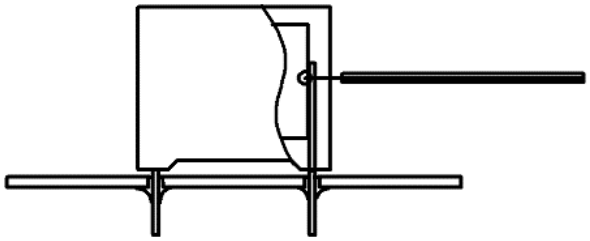
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process
Figure 1

Dielectric Film Material	Maximum Preheat Temperature			Maximum Peak Soldering Temperature	
	Capacitor Pitch ≤ 10 mm	Capacitor Pitch = 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:
Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



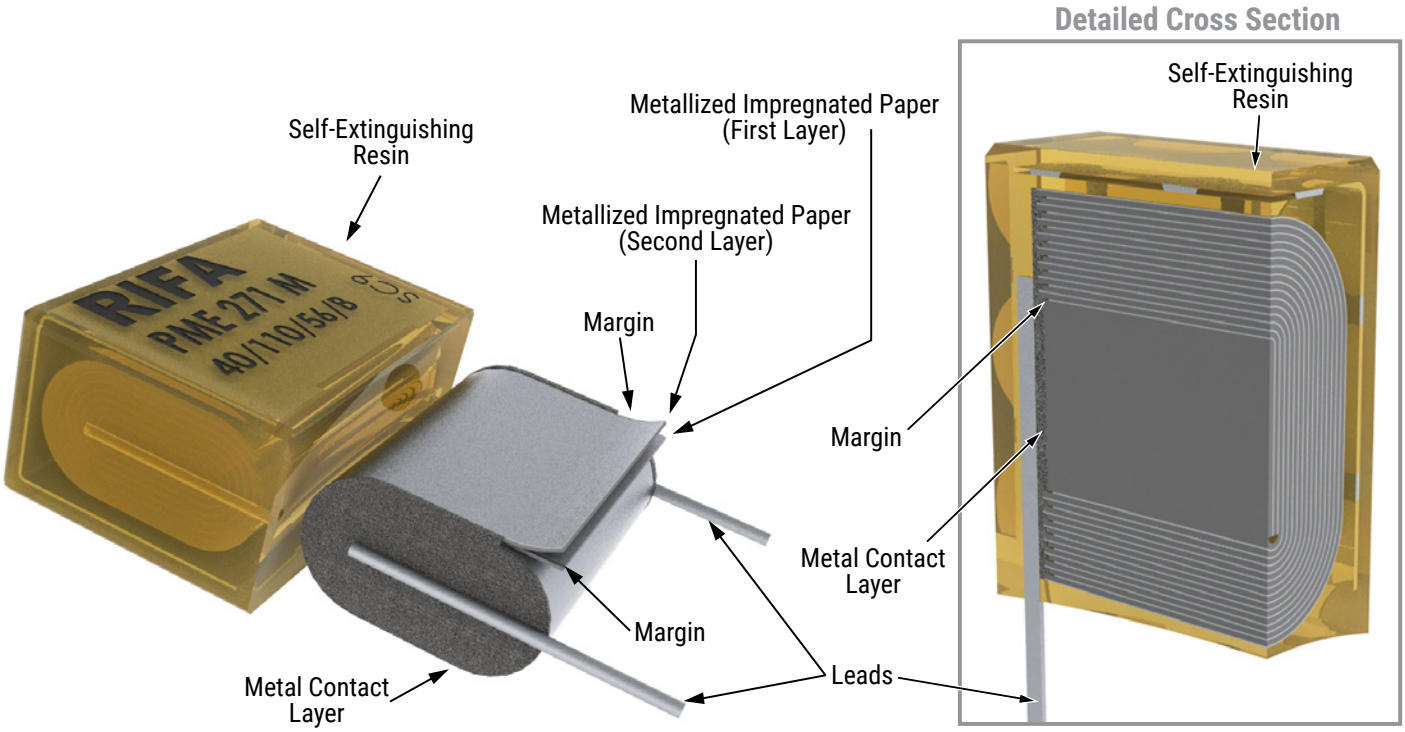
Temperature monitored inside the capacitor.

Selective Soldering Recommendations

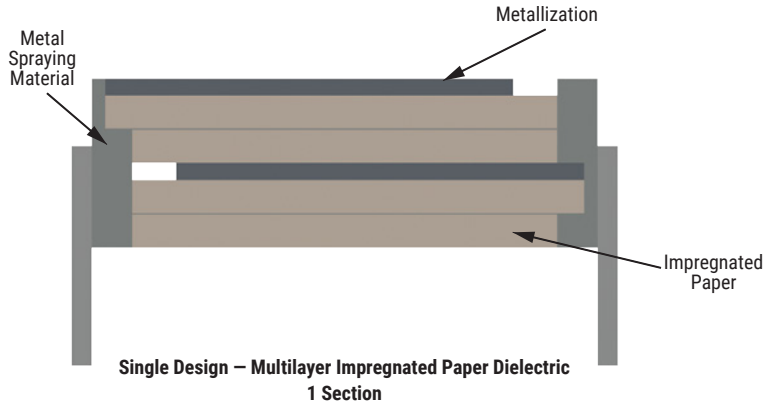
Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however, instead of two baths, there is only one bath with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.

Construction

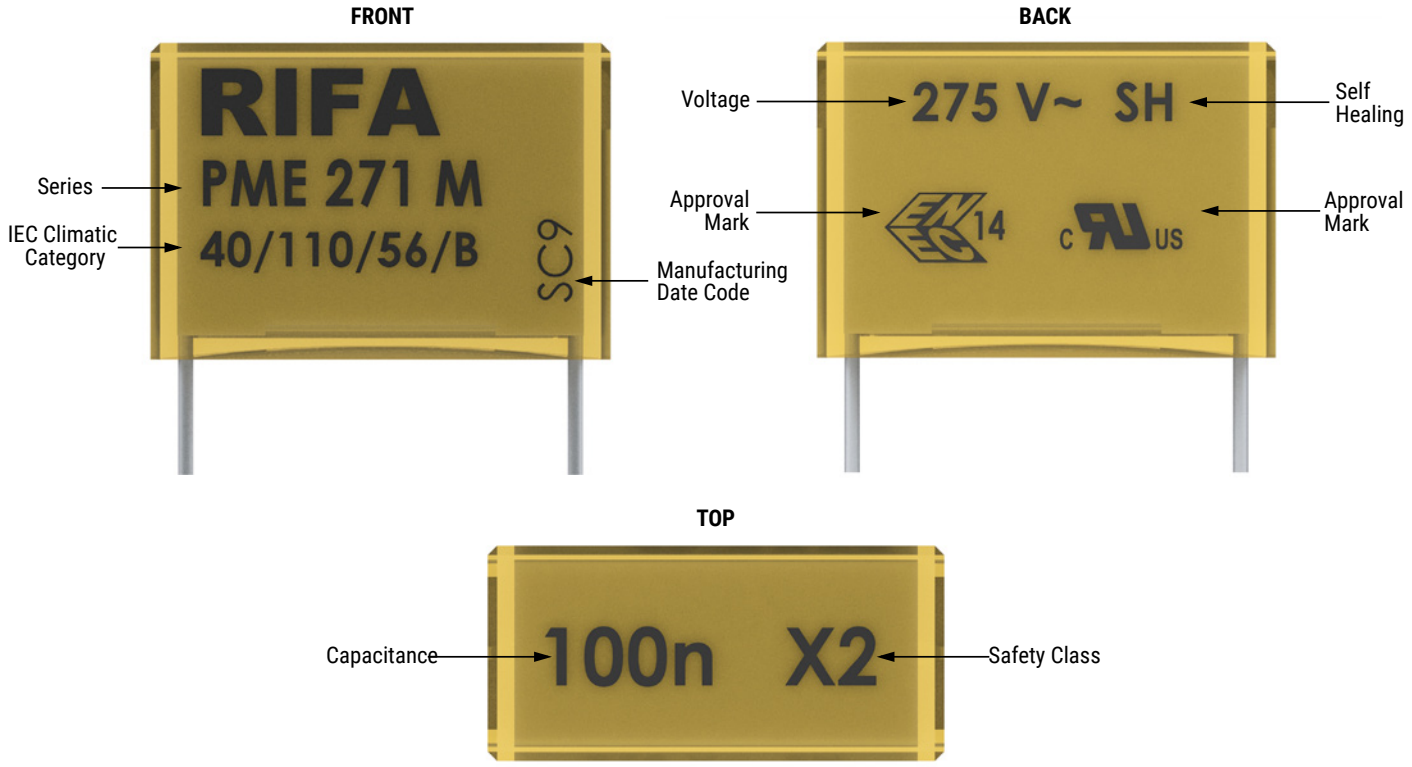


Winding Scheme



Single Design — Multilayer Impregnated Paper Dielectric
1 Section

Marking



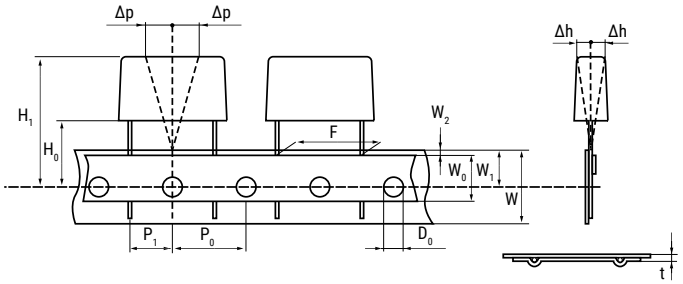
Manufacturing Date Code (IEC 60062)									
Year	Code	Year	Code	Year	Code	Month	Code	Month	Code
2020	M	2027	V	2034	E	January	1	July	7
2021	N	2028	W	2035	F	February	2	August	8
2022	P	2029	X	2036	H	March	3	September	9
2023	R	2030	A	2037	J	April	4	October	O
2024	S	2031	B	2038	K	May	5	November	N
2025	T	2032	C	2039	L	June	6	December	D
2026	U	2033	D	2040	M				

Packaging Quantities

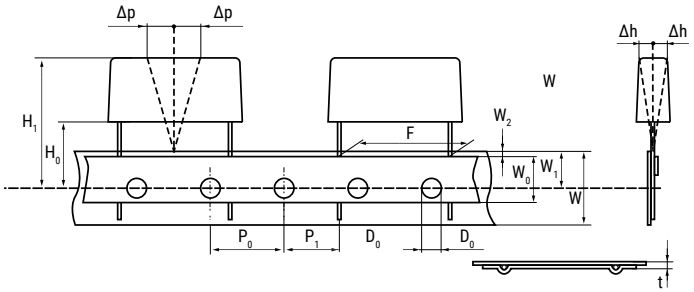
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel 360 mm	Large Reel 500 mm	Ammo Formed
10.2	3.9	7.5	13.5	2,000	1,000	700	1,400	800
	4.1	8.2	13.5	2,000	1,000	600		780
	5.1	10.5	13.5	1,600	800	600	1,200	630
15.2	5.5	12.5	18	1,000	500	600		
	6.5	12.5	18	600	400	400		
	7.5	14.5	18	600	400	400		
	8.5	16	18	400	250	400		
	5.2	10.5	18.5	1,000	500	600		
	5.5	11	18.5	1,000	500	500		
	6	12.5	18.5	600	400	400		
	7.3	13	18.5	600	400	400	800	
	7.8	13.5	18.5	600	400	400		
	8.5	14.3	18.5	500	300	350		
20.3	7.6	14	24	1,500	250	250	500	
	8.4	14	24	1,200	200	250	500	
	9	15	24	1,500	200	250		
	11.3	16.5	24	1,000	150	180	400	
22.5	8	17	27	1,200	200			
	10	19	27	1,000	150	200		
	12	22	27	800	100	180	350	
25.4	10.6	16.1	30.5	1,000	150			
	10.5	17.3	30.5	1,000	100			
	12.1	19	30.5	800	100			
	15.3	22	30.5	600	75			

Lead Taping & Packaging (IEC 60286–2)

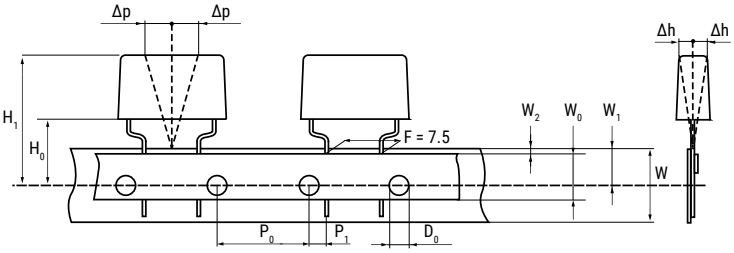
Lead Spacing 10.2 – 15.2 mm



Lead Spacing 20.3 – 22.5 mm



Formed Leads from 10.2 – 7.5 mm



Taping Specification

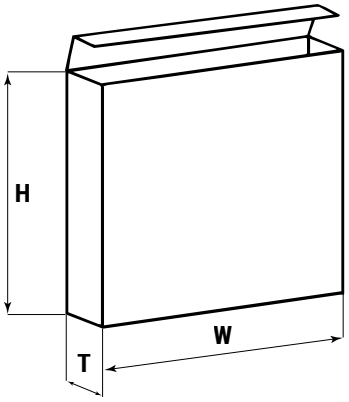
Dimensions in mm								Standard IEC 60286–2
Lead Spacing	+0.6/−0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F
Carrier Tape Width	±0.5	W	18.0	18.0	18.0	18.0	18.0	18 +1/−0.5
Hold-Down Tape Width	Minimum	W_0	5.0	5.0	5.0	5.0	5.0	
Position of Sprocket Hole	±0.5	W_1	9.0	9.0	9.0	9.0	9.0	9 +0.75/−0.5
Distance Between Tapes	Maximum	W_2	3.0	3.0	3.0	3.0	3.0	3.0
Sprocket Hole Diameter	±0.2	D_0	4.0	4.0	4.0	4.0	4.0	4.0
Feed Hole Lead Spacing	±0.3	P_0 (1)	12.7(4)	12.7	12.7	12.7	12.7	12.7
Distance Lead – Feed Hole	±0.7	P_1	3.75	7.6	5.1	8.9	5.3	P1
Deviation Tape – Plane	Maximum	Δp	1.3	1.3	1.3	1.3	1.3	1.3
Lateral Deviation	Maximum	Δh	2.0	2.0	2.0	2.0	2.0	2.0
Total Thickness	±0.2	t	0.7	0.7	0.7	0.7	0.9 Maximum	0.9 Maximum
Sprocket Hole/Cap Body	Nominal	H_0 (2)	18 +2/−0	18 +2/−0	18 +2/−0	18 +2/−0	18.5 ±0.5	18 +2/−0
Sprocket Hole/Top of Cap Body	Maximum	H_1 (3)	43	43	43	58	58	58 Maximum

(1) Maximum cumulative feed hole error, 1 mm per 20 parts
(2) 16.5 mm available on request
(3) Depending on case size
(4) 15 mm available on request

Lead Taping & Packaging (IEC 60286–2) cont.

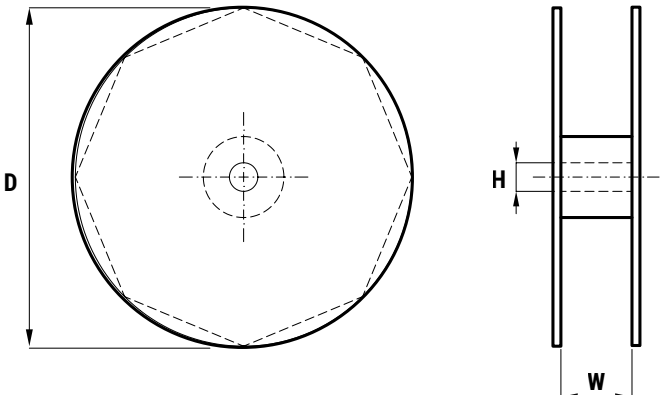
Ammo Specifications

Series	Dimensions (mm)		
	H	W	T
R4x, R4x+R, R7x, RSB	360	340	59
F5A, F5B, F5D			
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	330	330	50



Reel Specifications

Series	Dimensions (mm)		
	D	H	W
R4x, R4x+R, R7x, RSB	355 500	30 25	55 (Max)
F5A, F5B, F5D			
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)



KEMET Electronics Corporation Sales Offices

For a complete list of our global sales offices, please visit www.kemet.com/sales.

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